

12V COMPLEMENTARY MEDIUM POWER TRANSISTOR IN SOT26


Features

- NPN + PNP Combination
- $BV_{CEO} > 12$ (-12)V
- $BV_{EBO} > 7$ (-7)V
- Continuous Collector Current $I_C = 5$ (-3.5)A
- $V_{CE(sat)} < 32$ (-70)mV @ 1A
- $R_{CE(sat)} = 25$ (45)mΩ
- **Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Description

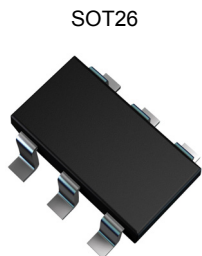
Advanced process capability has been used to achieve this high performance device. Combining NPN and PNP transistors in the SOT26 package provides a compact solution for the intended applications.

Mechanical Data

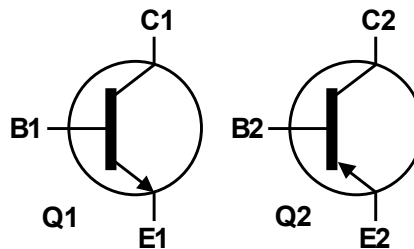
- Case: SOT26
- Case Material: Molded Plastic, "Green" Molding Compound
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 
- Weight: 0.015 grams (approximate)

Applications

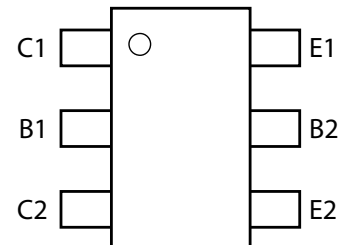
- MOSFET and IGBT Gate Driving
- Motor Drive



Top View



Device Symbol



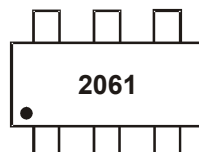
Top View
Pin-Out

Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTC2061E6TA	2061	7	8	3,000

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See <http://www.diodes.com/> for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com>

Marking Information



2061 = Product Type Marking Code

Maximum Ratings – Q1 (NPN Transistor) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	20	V
Collector-Emitter Voltage	V _{CEO}	12	V
Emitter-Base Voltage	V _{EBO}	7	V
Continuous Collector Current	I _C	5	A
Peak Pulsed Collector Current	I _{CM}	12	A
Base Current	I _B	1	A

Maximum Ratings – Q2 (PNP Transistor) (@T_A = +25°C, unless otherwise specified.)

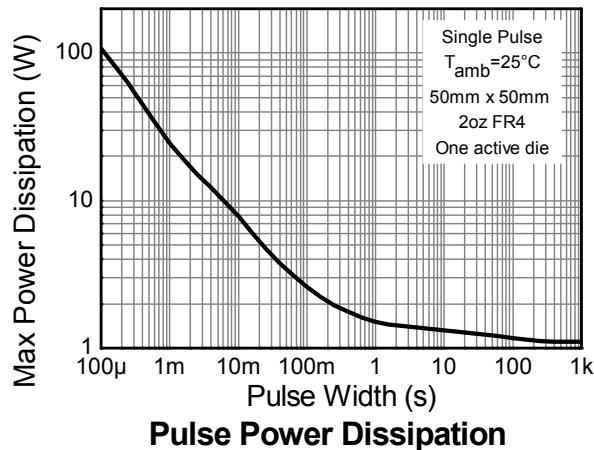
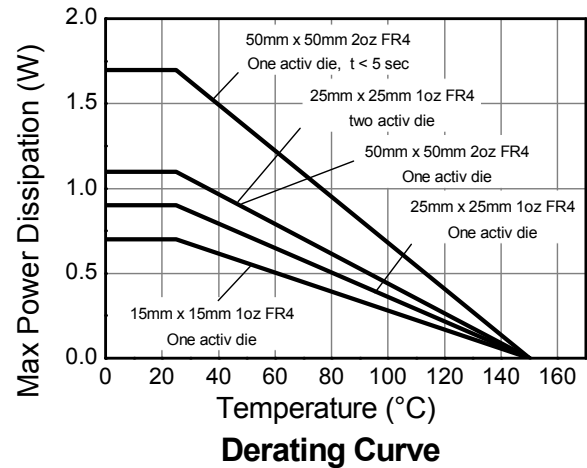
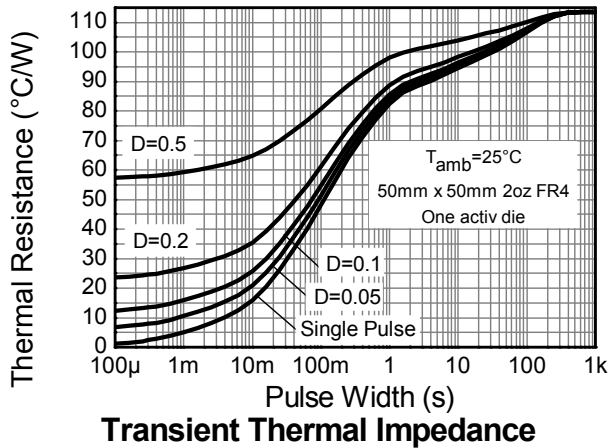
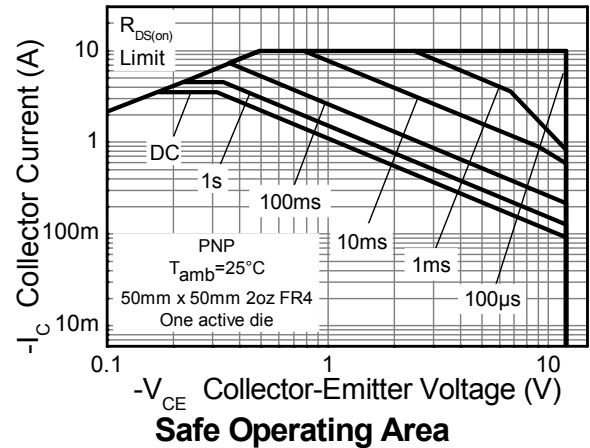
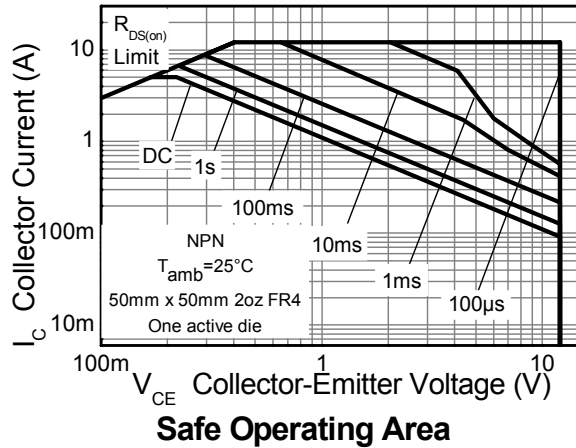
Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-12	V
Collector-Emitter Voltage	V _{CEO}	-12	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current	I _C	-3.5	A
Peak Pulsed Collector Current	I _{CM}	-10	A
Base Current	I _B	-1	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Power Dissipation Linear Derating Factor	(Notes 5 & 9)	P _D	0.7	W mW/°C
	(Notes 6 & 9)		5.6	
	(Notes 6 & 10)		0.9	
	(Notes 7 & 9)		7.2	
	(Notes 8 & 9)		1.1	
	(Notes 8 & 9)		8.8	
Thermal Resistance, Junction to Ambient	(Notes 5 & 9)	R _{θJA}	1.1	°C/W
	(Notes 6 & 9)		8.8	
	(Notes 6 & 10)		1.7	
	(Notes 7 & 9)		13.6	
	(Notes 8 & 9)		179	
Thermal Resistance, Junction to Lead	(Note 11)	R _{θJL}	139	°C
Operating and Storage Temperature Range		T _J , T _{STG}	113	
			73	
			87.58	
			-55 to +150	

- Notes:
- For a device surface mounted on 15mm x 15mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
 - Same as note (5), except the device is surface mounted on 25mm x 25mm 1oz copper.
 - Same as note (5), except the device is surface mounted on 50mm x 50mm 2oz copper.
 - Same as note (7), except the device is measured at t < 5 seconds.
 - For device with one active die, both collectors attached to a common heatsink.
 - For device with two active dice running at equal power, split heatsink 50% to each collector.
 - Thermal resistance from junction to solder-point (at the end of the collector lead).

Thermal Characteristics and Derating Information



Electrical Characteristics – Q1 (NPN Transistor) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV _{CBO}	20	40	—	V	I _C = 100μA, I _E = 0
Collector-Emitter Breakdown Voltage (Note 12)	BV _{CEO}	12	17	—	V	I _C = 10mA, I _B = 0
Emitter-Base Breakdown Voltage	BV _{EBO}	7	8.4	—	V	I _E = 100μA, I _C = 0
Collector Cutoff Current	I _{CBO}	—	<1	50 0.5	nA μA	V _{CB} = 20V V _{CB} = 20V, T _A = +100°C
Collector Cutoff Current	I _{EBO}	—	<1	50	nA	V _{EB} = 5.6V
ON CHARACTERISTICS (Note 12)						
DC Current Gain	h _{FE}	500 480 260	800 750 390	1500	—	I _C = 10mA, V _{CE} = 2V I _C = 1.0A, V _{CE} = 2V I _C = 5A, V _{CE} = 2V
Collector-Emitter Saturation Voltage	V _{CE(sat)}	—	32 50 65 145	40 60 80 180	mV	I _C = 1.0A, I _B = 100mA I _C = 1.0A, I _B = 10mA I _C = 2.0A, I _B = 40mA I _C = 5A, I _B = 100mA
Base-Emitter Saturation Voltage	V _{BE(sat)}	—	920	1000	mV	I _C = 5A, I _B = 100mA
Base-Emitter Turn-On Voltage	V _{BE(on)}	—	810	900	mV	I _C = 5A, V _{CE} = 2V
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	C _{obo}	—	26	35	pF	V _{CB} = 10V, f = 1.0MHz
Current Gain-Bandwidth Product	f _T	—	260	—	MHz	V _{CE} = 10V, I _C = 50mA, f = 100MHz
Delay Time	t _d	—	71	—	ns	V _{CC} = 10V, I _C = 1A, I _{B1} = -I _{B2} = 10mA
Rise Time	t _r	—	70	—	ns	
Storage Time	t _s	—	233	—	ns	
Fall Time	t _f	—	72	—	ns	

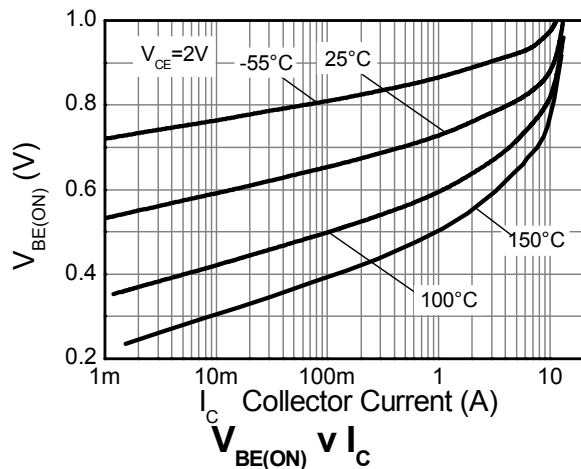
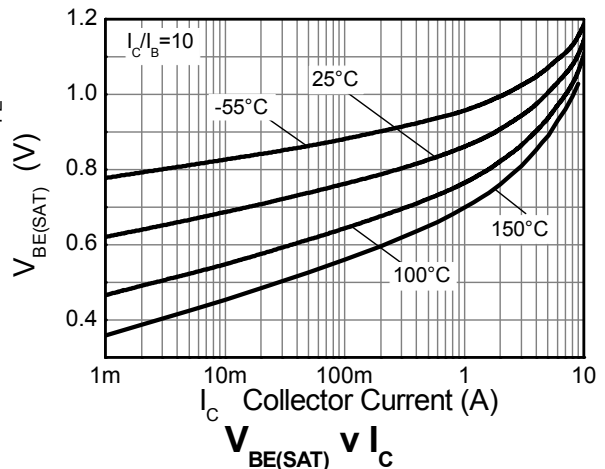
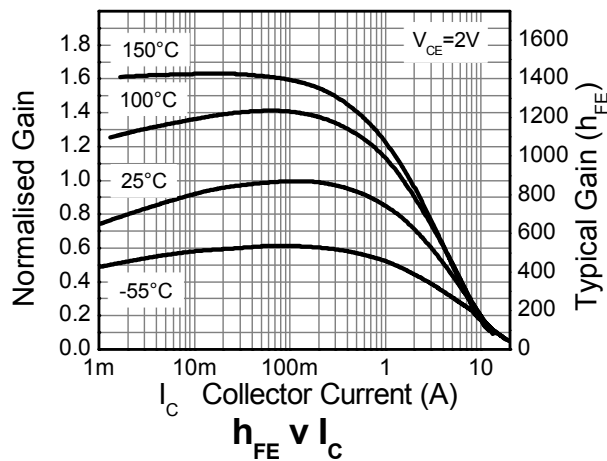
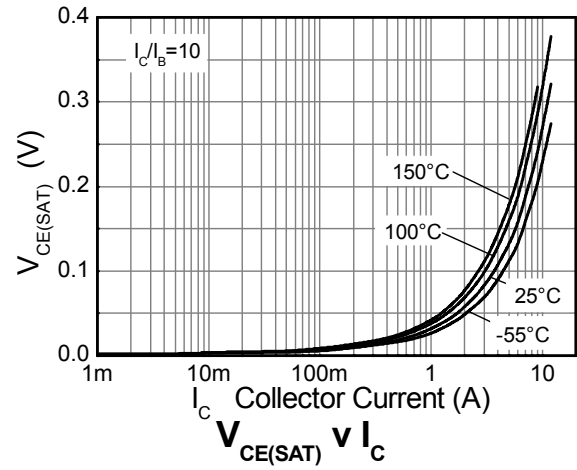
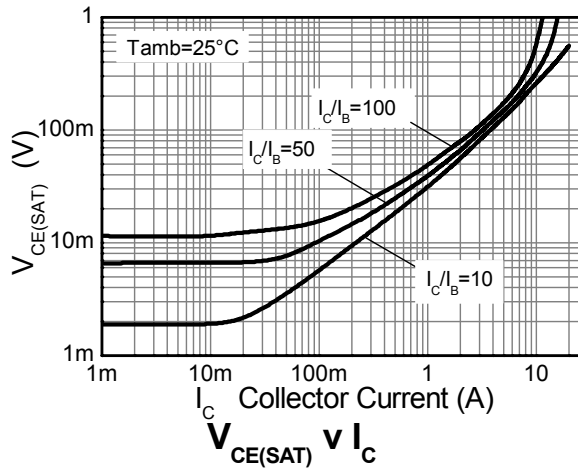
Notes: 12. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

Electrical Characteristics – Q2 (PNP Transistor) (@T_A = +25°C, unless otherwise specified.)

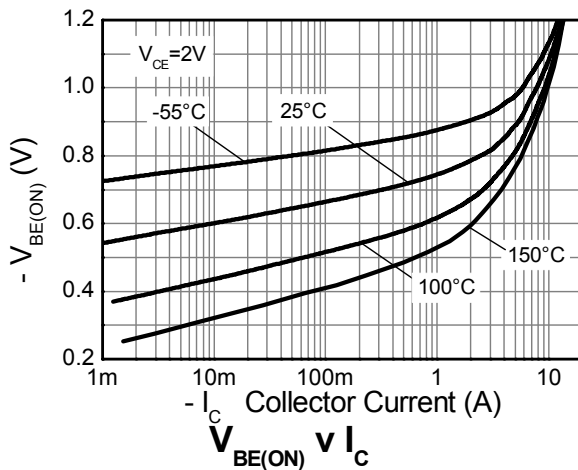
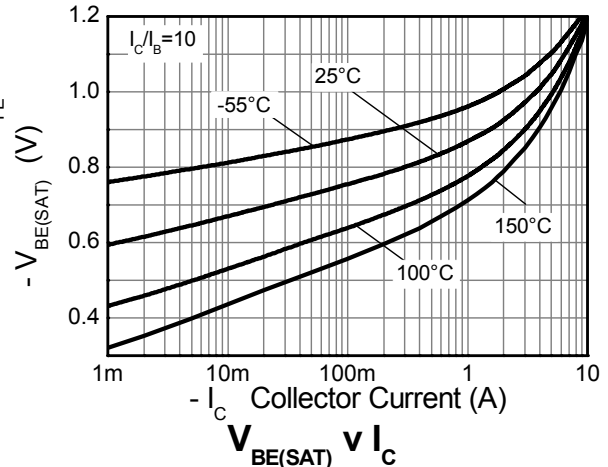
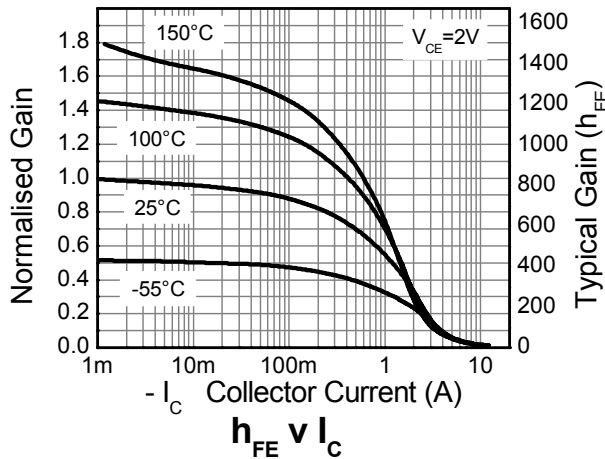
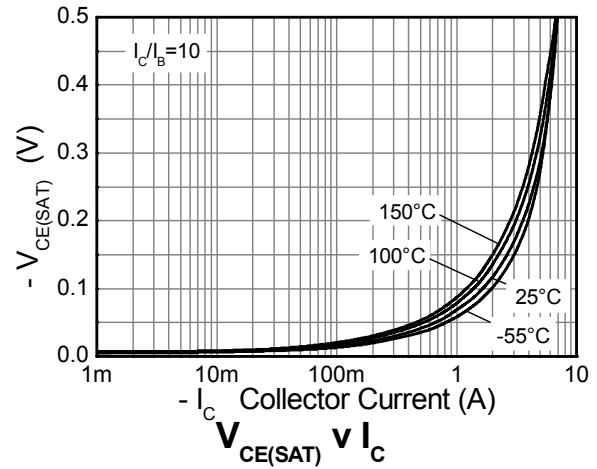
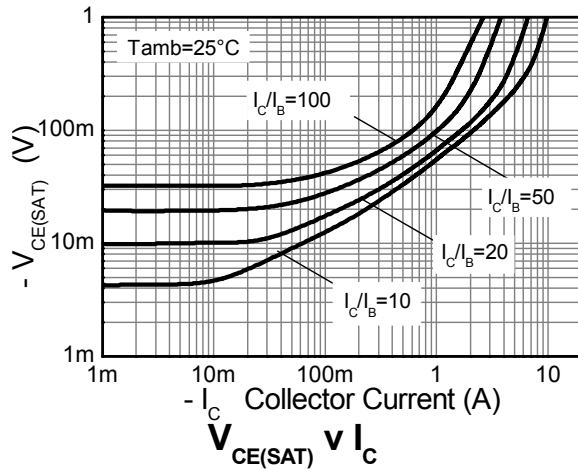
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV _{CBO}	-12	-35	—	V	I _C = -100μA, I _E = 0
Collector-Emitter Breakdown Voltage (Note 12)	BV _{CEO}	-12	-25	—	V	I _C = -10mA, I _B = 0
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	-8.4	—	V	I _E = -100μA, I _C = 0
Collector Cutoff Current	I _{CBO}	—	< -1	-50	nA	V _{CB} = -12V
Collector Cutoff Current	I _{EBO}	—	< -1	-50	nA	V _{CB} = -12V, T _A = +100°C
Collector Cutoff Current	I _{EBO}	—	< -1	-50	nA	V _{EB} = -5.6V
ON CHARACTERISTICS (Note 12)						
DC Current Gain	h _{FE}	500 290 75	800 450 100	1500 — —	—	I _C = -10mA, V _{CE} = -2V I _C = -1.0A, V _{CE} = -2V I _C = -3.5A, V _{CE} = -2V
Collector-Emitter Saturation Voltage	V _{CE(sat)}	— — — —	-55 -170 -220 -150	-70 -265 -360 -200	mV	I _C = -1.0A, I _B = -100mA I _C = -1.0A, I _B = -10mA I _C = -2.0A, I _B = -40mA I _C = -3.5A, I _B = -350mA
Base-Emitter Saturation Voltage	V _{BE(sat)}	—	-955	-1050	mV	I _C = -3.5A, I _B = -350mA
Base-Emitter Turn-On Voltage	V _{BE(on)}	—	-830	-900	mV	I _C = -3.5A, V _{CE} = -2V
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	C _{obo}	—	17	25	pF	V _{CB} = -10V, f = 1.0MHz
Current Gain-Bandwidth Product	f _T	—	310	—	MHz	V _{CE} = -10V, I _C = -50mA, f = 100MHz
Delay Time	t _d	—	41	—	ns	V _{CC} = -10V, I _C = -1A, I _{B1} = -I _{B2} = -10mA
Rise Time	t _r	—	62	—	ns	
Storage Time	t _s	—	179	—	ns	
Fall Time	t _f	—	65	—	ns	

Notes: 12. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

Typical Electrical Characteristics – Q1 (NPN Transistor) (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

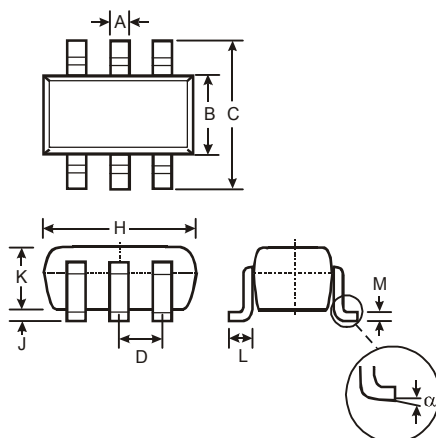


Typical Electrical Characteristics – Q2 (PNP Transistor) (@T_A = +25°C, unless otherwise specified.)



Package Outline Dimensions

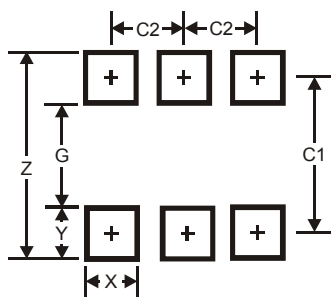
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SOT26			
Dim	Min	Max	Typ
A	0.35	0.50	0.38
B	1.50	1.70	1.60
C	2.70	3.00	2.80
D	—	—	0.95
H	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
M	0.10	0.20	0.15
α	0°	8°	—
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
Z	3.20
G	1.60
X	0.55
Y	0.80
C1	2.40
C2	0.95

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